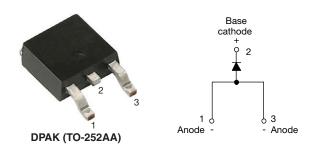
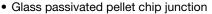


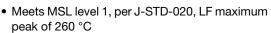
## Surface Mount Fast Soft Recovery Rectifier Diode, 8 A



PRIMARY CHARACTERISTICS						
I <sub>F(AV)</sub>	8 A					
V <sub>R</sub>	600 V					
V <sub>F</sub> at I <sub>F</sub>	1.2 V					
I <sub>FSM</sub>	150 A					
t <sub>rr</sub>	55 ns					
T <sub>J</sub> max.	150 °C					
Snap factor	0.5					
Package	DPAK (TO-252AA)					
Circuit configuration	Single					

#### **FEATURES**







- AEC-Q101 qualified
- Meets JESD 201 class 2 whisker test
- Flexible solution for reliable AC power rectification
- High surge, low V<sub>F</sub> rugged blocking diode for DC charging stations
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- On-board and off-board EV / HEV battery chargers
- Renewable energy inverters

#### **DESCRIPTION**

The VS-8EWF06SLHM3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time, low forward voltage drop and low leakage current.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL CHARACTERISTICS VALUES UNITS								
I <sub>F(AV)</sub>	Sinusoidal waveform	8	Α					
$V_{RRM}$		600	V					
I <sub>FSM</sub>		150	A					
V <sub>F</sub>	8 A, T <sub>J</sub> = 25 °C	1.2	V					
t <sub>rr</sub>	1 A, 100 A/μs	55	ns					
TJ	Range	-40 to +150	°C					

VOLTAGE RATINGS			
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I <sub>RRM</sub> AT 150 °C mA
VS-8EWF06SLHM3	600	700	3

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum average forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 96 °C, 180° conduction half sine wave	8				
Maximum peak one cycle		10 ms sine pulse, rated V <sub>RRM</sub> applied 125		Α			
non-repetitive surge current	I <sub>FSM</sub>	10 ms sine pulse, no voltage reapplied	150				
Maximum I <sup>2</sup> t for fusing	ım l <sup>2</sup> t for fusina l <sup>2</sup> t	10 ms sine pulse, rated V <sub>RRM</sub> applied	78	A <sup>2</sup> s			
Maximum i-t for fusing	I-t	10 ms sine pulse, no voltage reapplied	110	A-S			
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 ms to 10 ms, no voltage reapplied	1100	A²√s			



ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL TEST CONDITIONS VALUES UNIT						
Maximum forward voltage drop	$V_{FM}$	8 A, T <sub>J</sub> = 25 °C		1.2	V		
Forward slope resistance	r <sub>t</sub>	T <sub>.1</sub> = 150 °C	16	mΩ			
Threshold voltage	V <sub>F(TO)</sub>	1j = 150 C	IJ = 150 °C				
Maximum reverse leakage current	1	T <sub>J</sub> = 25 °C	$V_{B}$ = rated $V_{BBM}$	0.1	mA		
Maximum reverse leakage current	IRM	T <sub>J</sub> = 150 °C	VR = rated VRRM	3	IIIA		

RECOVERY CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> at 1 A <sub>pk</sub> 100 A/µs T <sub>J</sub> = 25 °C	55	ns	I <sub>FM</sub>	
		l- at 8 Δ .	200		t <sub>a</sub> t <sub>b</sub>	
Reverse recovery current	I <sub>rr</sub>	I <sub>F</sub> at 8 A <sub>pk</sub> 25 A/µs	2.6	Α	di	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C	0.25	μC	at I <sub>rr</sub>	
Snap factor	S		0.5			

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-40 to +150	°C		
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation	2.5	°C/W		
Typical thermal resistance, junction to ambient (PCB mount)	R <sub>thJA</sub> <sup>(1)</sup>		50	C/VV		
Approximate weight			1	g		
Approximate weight			0.03	OZ.		
Marking device		Case style DPAK (TO-252AA)	8EWF0	D6SH		

### Note

<sup>(1)</sup> When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W

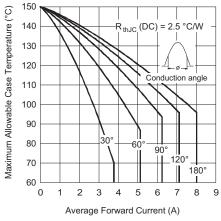


Fig. 1 - Current Rating Characteristics

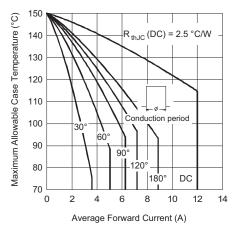


Fig. 2 - Current Rating Characteristics

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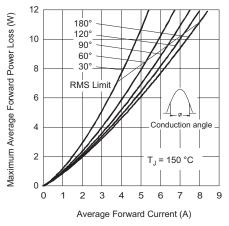


Fig. 3 - Forward Power Loss Characteristics

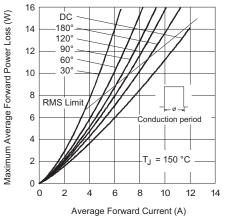


Fig. 4 - Forward Power Loss Characteristics

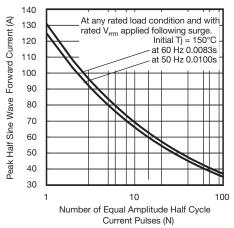


Fig. 5 - Maximum Non-Repetitive Surge Current

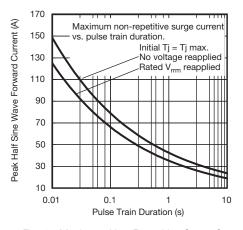


Fig. 6 - Maximum Non-Repetitive Surge Current

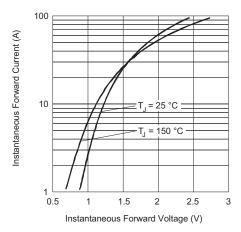


Fig. 7 - Forward Voltage Drop Characteristics

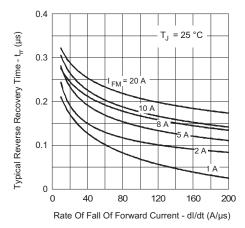


Fig. 8 - Recovery Time Characteristics, T<sub>J</sub> = 25 °C

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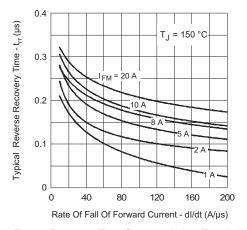


Fig. 9 - Recovery Time Characteristics, T<sub>J</sub> = 150 °C

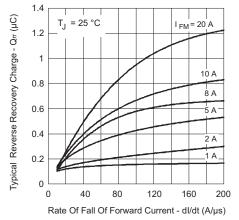


Fig. 10 - Recovery Charge Characteristics,  $T_J = 25$  °C

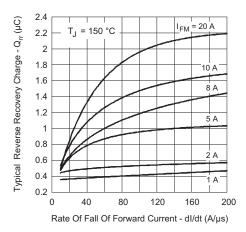


Fig. 11 - Recovery Charge Characteristics, T<sub>J</sub> = 150 °C

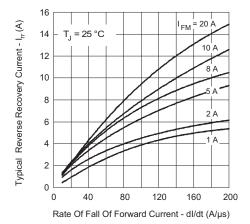


Fig. 12 - Recovery Current Characteristics,  $T_J = 25\ ^{\circ}\text{C}$ 

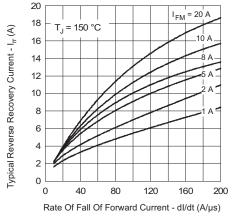


Fig. 13 - Recovery Current Characteristics, T<sub>J</sub> = 150 °C

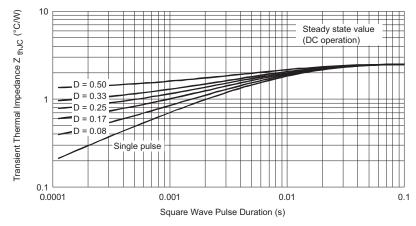


Fig. 14 - Thermal Impedance Z<sub>thJC</sub> Characteristics

#### **ORDERING INFORMATION TABLE**

Device code VS-8 Ε W F 06 S L Н **M3** (2) 3) (5) (6) (7)(8) (10)4 Vishay Semiconductors product Current rating (8 = 8 A) Circuit configuration: E = single Package: W = DPAK (TO-252AA)5 Type of silicon: F = fast soft recovery rectifier Voltage code x 100 = V<sub>RRM</sub> 06 = 600 V

8	-	L = tape and reel (left oriented), for different orientation contact factory
_		

9 - H = AEC-Q101 qualified

S = surface mountable

10 - Environmental digit:

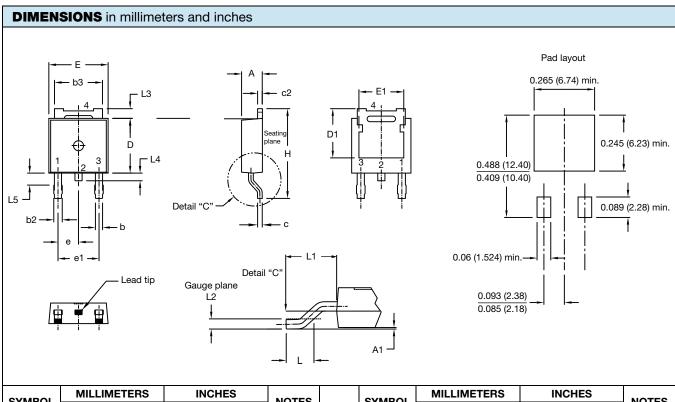
M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-8EWF06SLHM3	3000	3000	13" diameter reel				

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95519			
Part marking information	www.vishay.com/doc?95518			
Packaging information	www.vishay.com/doc?96495			



## **DPAK (TO-252AA)**



SYMBOL	MILLIN	IETERS	INC	NOTES	
STINIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	2.18	2.39	0.086	0.094	
A1	1	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	4.93	-	0.194	-	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

SYMBOL	CAMBOI   MILLIMETERS   INCHES		HES	NOTES	
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
е	2.29	BSC	0.090	BSC	
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.108	REF.	
L2	0.51	BSC	0.020	BSC	
L3	0.89	1.27	0.035	0.050	3
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2
	•	•		•	

#### **Notes**

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Dimensions D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (5) Outline conforms to JEDEC® outline TO-252AA, except for D1 dimension



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